

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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 $I_{FAV} = 2x 20 A$



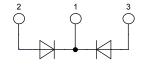
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Sonic Fast Recovery Diode

High Performance Fast Recovery Diode Low Loss and Soft Recovery Common Cathode

Part number

DHG 40 C 600 HB



1 3

600 V

40 ns

Backside: cathode

Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very short recovery time
- · Improved thermal behaviour
- Very low Irm-values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low Irm reduces:
 - Power dissipation within the diode
 - Turn-on loss in the commutating switch

Applications:

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

Package:

 $V_{RRM} =$

- Housing: TO-247
- Industry standard outline
- Epoxy meets UL 94V-0
- RoHS compliant

Ratings

Symbol	Definition	Conditions		min.	typ.	max.	Unit
V _{RRM}	max. repetitive reverse voltage		T _{VJ} = 25°C			600	V
I _R	reverse current	V _R = 600 V	$T_{VJ} = 25^{\circ}C$			25	μΑ
		$V_{R} = 600 V$	$T_{VJ} = 125$ °C			1.5	mΑ
V _F	forward voltage	I _F = 20 A	T _{VJ} = 25°C			2.24	V
		$I_F = 40 A$				3.15	V
		I _F = 20 A	T _{VJ} = 125°C			2.19	V
		$I_F = 40 A$				3.21	V
I _{FAV}	average forward current	rectangular d = 0.5	$T_{\rm C} = 95^{\circ}C$			20	Α
V _{F0}	threshold voltage		T _{vJ} = 150°C			1.12	V
r _F	slope resistance	calculation only				49	mΩ
R _{thJC}	thermal resistance junction to case					0.90	K/W
T _{VJ}	virtual junction temperature			-55		150	°C
P _{tot}	total power dissipation		$T_{\rm C} = 25^{\circ}{\rm C}$			140	W
I _{FSM}	max. forward surge current	t = 10 ms (50 Hz), sine	$T_{VJ} = 45^{\circ}C$			150	Α
I _{RM}	max. reverse recovery current		$T_{VJ} = 25^{\circ}C$		8		Α
		$I_F = 20 \text{ A}; V_R = 300 \text{ V}$	$T_{VJ} = 125^{\circ}C$		12		Α
t _{rr}	reverse recovery time	$-di_F/dt = 450 A/\mu s$	$T_{VJ} = 25^{\circ}C$		40		ns
			$T_{VJ} = 125^{\circ}C$		60		ns
C¹	junction capacitance	$V_R = 400 V; f = 1 MHz$	$T_{VJ} = 25^{\circ}C$		12		pF



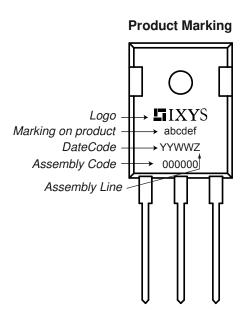
DHG 40 C 600 HB

Ratings

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Symbol	Definition	Conditions	min.	typ.	max.	Unit
I _{RMS}	RMS current	per terminal 1)			70	Α
R thCH	thermal resistance case to heatsink			0.25		K/W
T _{stg}	storage temperature		-55		150	°C
Weight				6		g
M _D	mounting torque		0.8		1.2	Nm
F _c	mounting force with clip		20		120	Ν

 $^{^{1)}}$ I_{RMS} is typically limited by the pin-to-chip resistance (1); or by the current capability of the chip (2). In case of (1) and a common cathode/anode configuration with a non-isolated backside, the current capability can be increased by connecting the backside.



Part number

D = Diode

H = Sonic Fast Recovery Diode

G = extreme fast

40 = Current Rating [A]

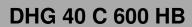
C = Common Cathode

600 = Reverse Voltage [V]

HB = TO-247AD (3)

Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	DHG 40 C 600 HB	DHG40C600HB	Tube	30	505145

Similar Part	Package	Voltage Class
DHG40C600PB	TO-220AB (3)	600

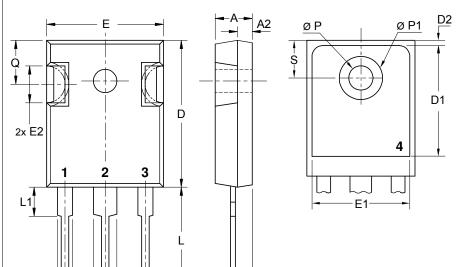




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Outlines TO-247

2x b2



−3x b

Sym.	Inches		Millim	eter
	min.	max.	min.	max.
Α	0.185	0.209	4.70	5.30
A1	0.087	0.102	2.21	2.59
A2	0.059	0.098	1.50	2.49
D	0.819	0.845	20.79	21.45
E	0.610	0.640	15.48	16.24
E2	0.170	0.216	4.31	5.48
е	0.215 BSC		5.46 BSC	
L	0.780	0.800	19.80	20.30
L1	-	0.177	-	4.49
ØР	0.140	0.144	3.55	3.65
Q	0.212	0.244	5.38	6.19
S	0.242 BSC		6.14 BSC	
b	0.039	0.055	0.99	1.40
b2	0.065	0.094	1.65	2.39
b4	0.102	0.135	2.59	3.43
С	0.015	0.035	0.38	0.89
D1	0.515	-	13.07	-
D2	0.020	0.053	0.51	1.35
E1	0.530	-	13.45	-
Ø P1	-	0.29	-	7.39

DHG 40 C 600 HB

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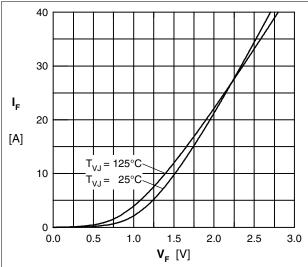


Fig. 1 Typ. Forward current versus V_F

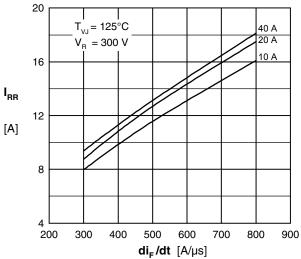


Fig. 3 Typ. peak reverse current I_{RM} vs. di/dt

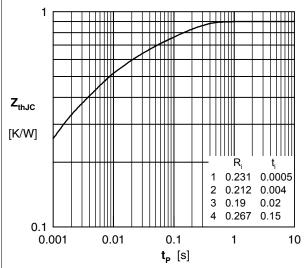


Fig. 5 Typ. transient thermal impedance

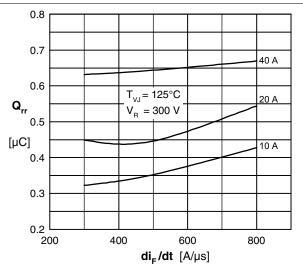


Fig. 2 Typ. reverse recov.charge Q_{rr} vs. di/dt

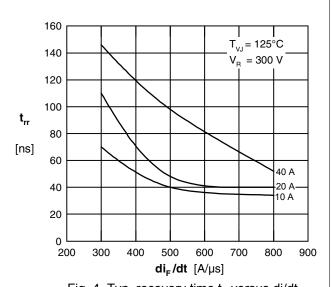


Fig. 4 Typ. recovery time $t_{\rm rr}$ versus di/dt